

PC/104 and Small Form Factors 2012 Print and E-letter Editorial Calendar				Due Dates			Digital Updates
Issue	IT'S A SMALL (FORM FACTOR) WORLD: Design considerations in the following topics	THE BIG YET SMALL PICTURE: Application examples, systems, case studies on various SFF topics	Promotions and Tradeshows	Abstracts	Articles	Ads	E-casts and Virtual Events*
Spring Print Issue	Annual PC/104 and Small Form Factor's Resource Guide Distributed with <i>Embedded Computing Design</i> March print issue			12/16/11	1/13/12	1/23/12	EHealth Multicore Android/Linux*
	Categories: Communications, Complete systems, Industrial automation, Interfaces, I/O boards, MIL-SPEC, Packaging, Processor boards/SBCs, Storage, Vision systems and displays, Rugged RAM and SSD/Flash	Portable Mobile Devices Including: Medical, industrial, and commercial portable devices	Smart energy system application examples, systems, and case studies				
Spring Product E-letter	PC/104 and Small Form Factors Product-only E-letter			-	-	3/1/12	
Summer Print Issue	PC/104 and the PC/104 Consortium turns 20! The past, present, and future of PC/104	COMs Including: Computers-On-Module (COMs) and Systems-On-Module (SOMs) technology	ESC Chicago	4/19/12	5/11/12	5/16/12	Apps in the Embedded World
Summer Product E-letter	PC/104 and Small Form Factors Product-only E-letter			-	-	6/1/12	
Fall Print Issue	Distributed with <i>Military Embedded Systems</i> September print issue			6/21/12	7/10/12	8/31/12	Digital Signage
	Mounted Mobile Devices Including: In-vehicle systems for military/rugged, automotive, industrial markets	Rugged and military application examples, systems, and case studies	ESC Boston				
Fall Product E-letter	PC/104 and Small Form Factors Product-only E-letter			-	-	8/31/12	
Winter Print Issue	Annual PC/104 and Small Form Factor's Buyer's Guide Featuring: Sponsored products and mini tabs			9/6/12	9/25/12	10/5/12	SWaP* Virtualization
	Categories: Communications, EPIC, ETX, Industrial automation, Mini-ITX, Packaging, PC/104, PC/104-Plus, PC/104-Express, Rugged/MIL-SPEC, Stand-alone systems, Storage, SUMIT	Latest USB Module Technologies Including: USB 3.0, high-speed USB 2.0	Data acquisition and analog I/O application examples, systems, and case studies				
Winter Product E-letter	PC/104 and Small Form Factors Product-only E-letter			-	-	11/21/12	